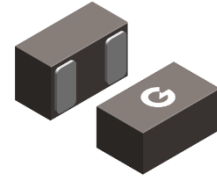


Features

- ESD / transient protection of high speed data lines
 - IEC 61000-4-2 (ESD): ± 20 kV (air), ± 20 kV (contact)
- Working voltage: $V_{RWM} = 5V$
- Very Low Leakage current
- Very low load capacitance
- RoHS compliant with Halogen-free

HF



DFN1006-2

Mechanical Data

- Case: DFN1006-2
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
GESD5V0X2BL	DFN1006-2	10000pcs / Tape & Reel	XY

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
IEC 61000-4-2; ESD (Air)	V_{ESD-A}	± 20	kV
IEC 61000-4-2; ESD (Contact)	V_{ESD-C}	± 20	kV
Peak Pulse Power ($t_p = 8/20\mu\text{s}$)	P_{PP}	100	W
Peak Pulse Current ($t_p = 8/20\mu\text{s}$)	I_{PP}	4	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	0.25	W
Thermal Resistance Junction-to-Air	$R_{\theta JA}$	400	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Lead	$R_{\theta JL}$	204	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	240	$^\circ\text{C/W}$
Junction Temperature	T_J	$-55 \sim +125$	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	$-55 \sim +150$	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Reverse Stand-off Voltage	V_{RWM}		-	-	5	V
Reverse Breakdown Voltage	$V_{\text{(BR)}}$	$I_T = 1\text{mA}$	6.5	7.5	9	V
Reverse Leakage Current	I_{R}	$V_{\text{RWM}} = 5\text{V}$	-	-	0.05	μA
Clamping Voltage	V_{C}	$I_{\text{PP}} = 1\text{A}$, $t_{\text{p}} = 8/20\mu\text{s}$	-	-	14	V
		$I_{\text{PP}} = 2\text{A}$, $t_{\text{p}} = 8/20\mu\text{s}$	-	-	17	V
		$I_{\text{PP}} = 4\text{A}$, $t_{\text{p}} = 8/20\mu\text{s}$	-	-	25	V
Junction Capacitance	C_{J}	$V_{\text{R}} = 0\text{V}$, $f = 1\text{MHz}$	-	0.35	0.4	pF

Ratings and Characteristic Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

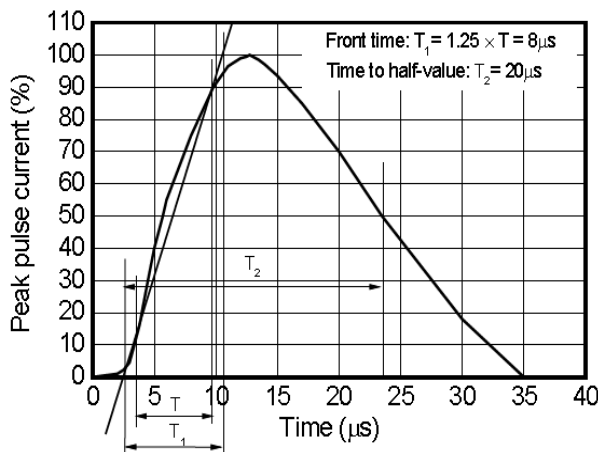


Fig 1 8/20 μs waveform per IEC61000-4-5

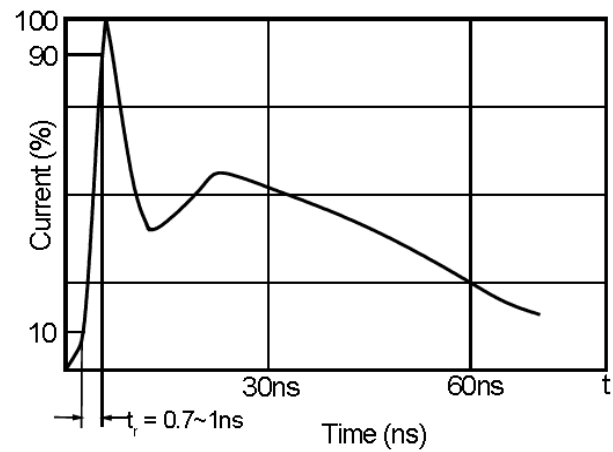


Fig 2 ESD pulse waveform according to IEC61000-4-2

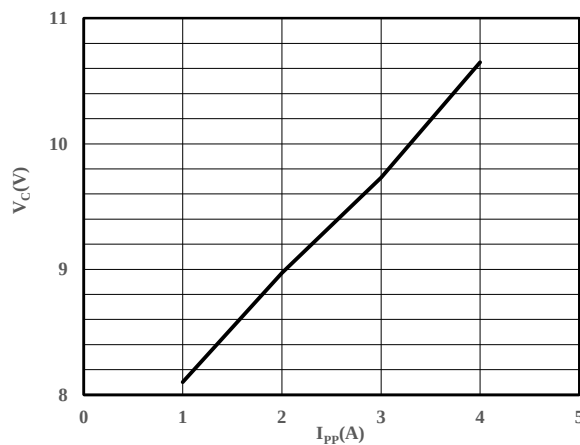


Fig 3 Clamping Voltage vs. Peak Pulse Current

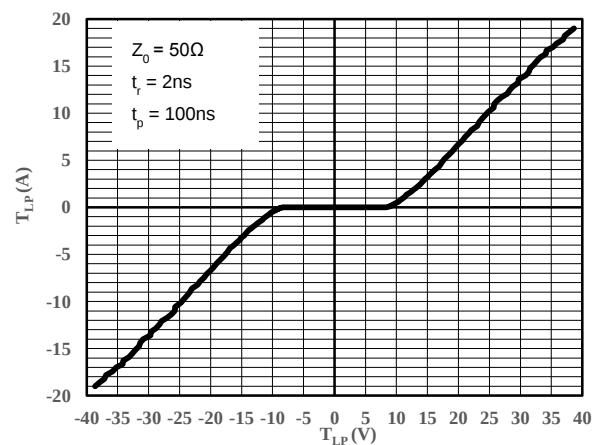


Fig 4 TLP Measurement

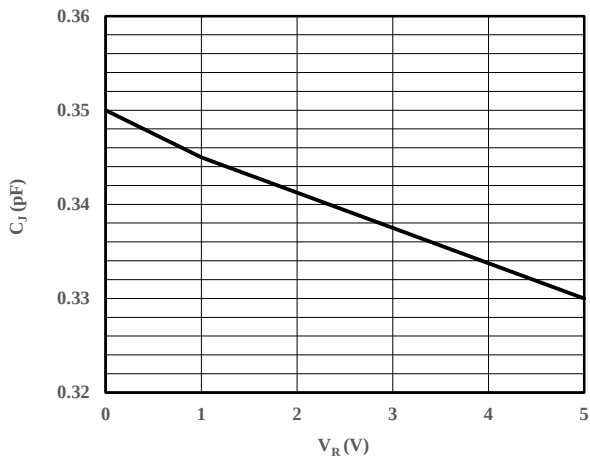
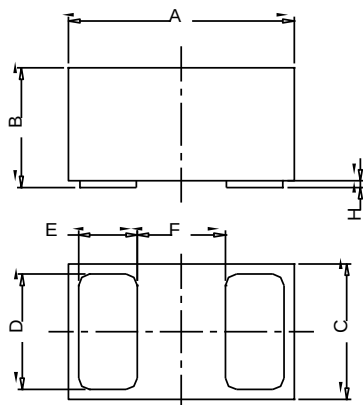


Fig 5 Capacitance Characteristics

Package Outline Dimensions (Unit: mm)



DFN1006-2			
Dimension	Min.	Typ.	Max.
A	0.95	1.00	1.075
B	0.45	0.50	0.55
C	0.55	0.60	0.675
D	0.45	0.50	0.55
E	0.20	0.25	0.30
F	-	0.40	-
H	0	0.03	0.05

Package Outline Dimensions (Unit: mm)

DFN1006-2

